



8N90

Preliminary

Power MOSFET

8A, 900V N-CHANNEL POWER MOSFET

DESCRIPTION

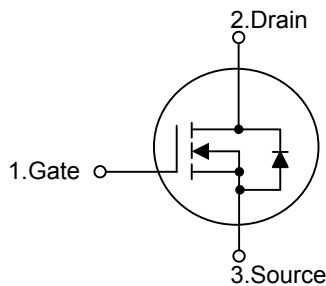
The UTC **8N90** is an N-channel mode power MOSFET, using UTC's advanced technology to provide customers planar stripe and DMOS technology. This technology allows a minimum on-state resistance, superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC **8N90** is generally applied in high efficiency switch mode power supplies.

FEATURES

- * $R_{DS(ON)}=1.55\Omega @ V_{GS}=10V$
- * Fast Switching Speed
- * 100% Avalanche Tested
- * Improved dv/dt Capability

SYMBOL

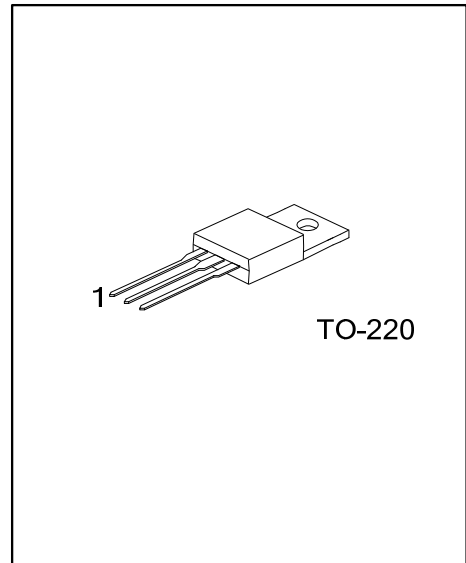


ORDERING INFORMATION

| Ordering Number | | Package | Pin Assignment | | | Packing |
|-----------------|--------------|---------|----------------|---|---|---------|
| Lead Free | Halogen Free | | 1 | 2 | 3 | |
| 8N90L-TA3-T | 8N90G-TA3-T | TO-220 | G | D | S | Tube |

Note: G: GND, D: Drain, S: Source

| | |
|---|--|
| <p>8N90G-TA3-T</p> <p>(1)Packing Type</p> <p>(2)Package Type</p> <p>(3)Halogen Free</p> | <p>(1) T: Tube</p> <p>(2) TA3: TO-220</p> <p>(3) G: Halogen Free, L: Lead Free</p> |
|---|--|



■ ABSOLUTE MAXIMUM RATINGS

| PARAMETER | SYMBOL | RATINGS | UNIT |
|---|-----------|----------|---------------------|
| Drain to Source Voltage | V_{DSS} | 900 | V |
| Gate to Source Voltage | V_{GSS} | ± 30 | V |
| Continuous Drain Current ($T_C=25^\circ\text{C}$) | I_D | 8 | A |
| Pulsed Drain Current (Note 1) | I_{DM} | 25 | A |
| Avalanche Current (Note 1) | I_{AR} | 6.3 | A |
| Single Pulsed Avalanche Energy (Note 2) | E_{AS} | 850 | mJ |
| Repetitive Avalanche Energy (Note 1) | E_{AR} | 17.1 | mJ |
| Peak Diode Recovery dv/dt (Note 3) | dv/dt | 4.0 | V/ns |
| Power Dissipation ($T_C=25^\circ\text{C}$) | P_D | 147 | W |
| Linear Derating Factor above $T_C=25^\circ\text{C}$ | | 1.17 | W/ $^\circ\text{C}$ |
| Junction Temperature | T_J | +150 | $^\circ\text{C}$ |
| Storage Temperature | T_{STG} | -55~+150 | $^\circ\text{C}$ |

Note: 1. Repetitive Rating : Pulse width limited by maximum junction temperature

2. $L=27\text{mH}$, $I_{AS}=8\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$

3. $I_{SD}\leq 8\text{A}$, $di/dt\leq 200\text{A}/\mu\text{s}$, $V_{DD}\leq BV_{DSS}$, Starting $T_J=25^\circ\text{C}$

4. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

| PARAMETER | SYMBOL | RATINGS | UNIT |
|---------------------|---------------|---------|---------------------------|
| Junction to Ambient | θ_{JA} | 62.5 | $^\circ\text{C}/\text{W}$ |
| Junction to Case | θ_{JC} | 0.85 | $^\circ\text{C}/\text{W}$ |

■ ELECTRICAL CHARACTERISTICS (T_c=25°C, unless otherwise specified)

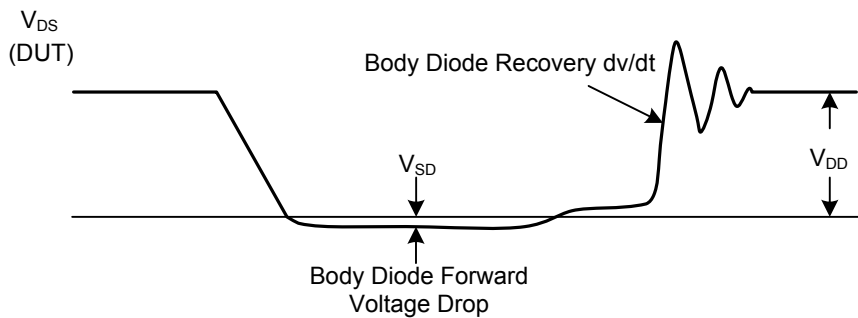
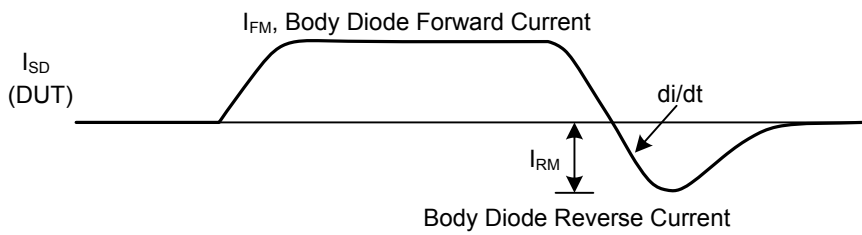
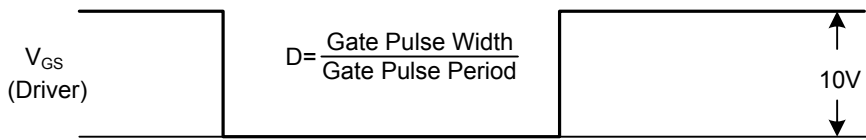
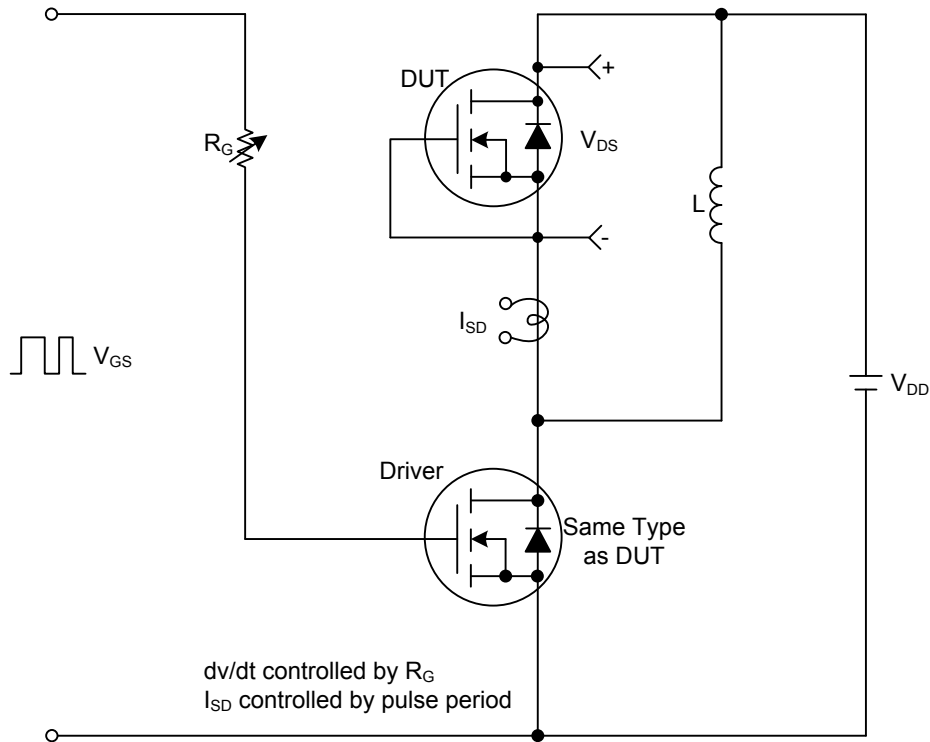
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|-------------------------------------|---|-----|------|------|------|
| OFF CHARACTERISTICS | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V, I _D =250μA | 900 | | | V |
| Breakdown Voltage Temperature Coefficient | ΔBV _{DSS} /ΔT _J | I _D =250μA, Referenced to 25°C | | 0.95 | | V/°C |
| Drain-Source Leakage Current | I _{DSS} | V _{DS} =900V, V _{GS} =0V | | | 10 | μA |
| | | V _{DS} =720V, T _C =125°C | | | 100 | μA |
| Gate-Source Leakage Current | I _{GSS} | V _{DS} =0V, V _{GS} =±30V | | | ±100 | nA |
| ON CHARACTERISTICS | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | V _{DS} =V _{GS} , I _D =250μA | 3.0 | | 5.0 | V |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =10V, I _D =4A | | 1300 | 1550 | mΩ |
| Forward Transconductance (Note 1) | g _{FS} | V _{DS} =50V, I _D =4A ⁴ | | 5.5 | | S |
| DYNAMIC PARAMETERS | | | | | | |
| Input Capacitance | C _{ISS} | V _{DS} =25V, V _{GS} =0V, f=1.0MHz | | 1600 | 2080 | pF |
| Output Capacitance | C _{OSS} | | | 130 | 170 | pF |
| Reverse Transfer Capacitance | C _{RSS} | | | 12 | 15 | pF |
| SWITCHING PARAMETERS (Note 1, Note 2) | | | | | | |
| Total Gate Charge | Q _G | V _{DS} =720V, V _{GS} =10V, I _D =8A | | 35 | 45 | nC |
| Gate-Source Charge | Q _{GS} | | | 10 | | nC |
| Gate-Drain Charge | Q _{GD} | | | 14 | | nC |
| Turn-ON Delay Time | t _{D(ON)} | V _{DD} =450V, I _D =8A, R _G =25Ω | | 40 | 90 | ns |
| Turn-ON Rise Time | t _R | | | 110 | 230 | ns |
| Turn-OFF Delay Time | t _{D(OFF)} | | | 70 | 150 | ns |
| Turn-OFF Fall Time | t _F | | | 70 | 150 | ns |
| SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS | | | | | | |
| Maximum Body-Diode Continuous Current | I _S | | | | 8 | A |
| Maximum Body-Diode Pulsed Current | I _{SM} | | | | 25 | A |
| Drain-Source Diode Forward Voltage | V _{SD} | I _S =8A, V _{GS} =0V | | | 1.4 | V |
| Body Diode Reverse Recovery Time | t _{rr} | V _{GS} =0V, I _S =8A, | | 530 | | ns |
| Body Diode Reverse Recovery Charge | Q _{RR} | di _F /dt=100A/μs (Note 1) | | 5.8 | | μC |

Note: 1. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%

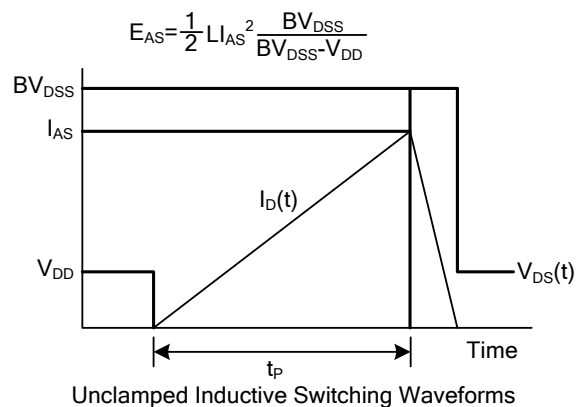
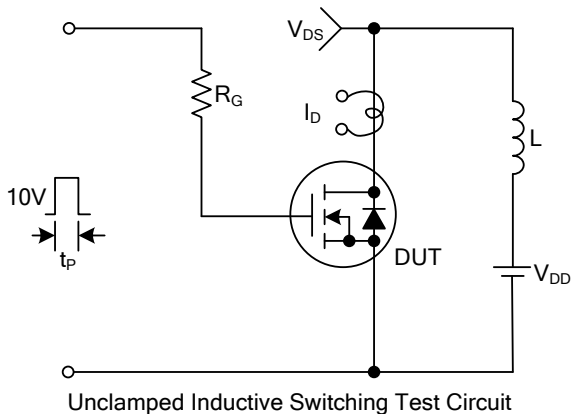
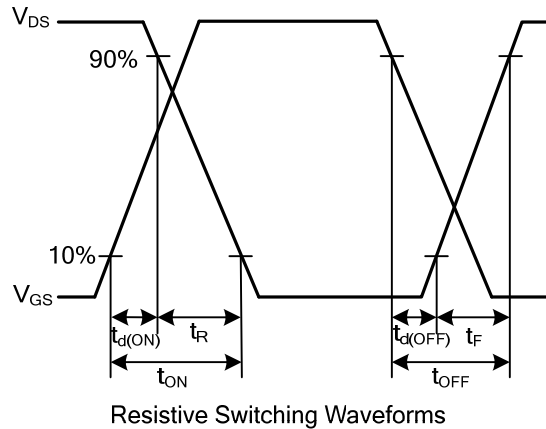
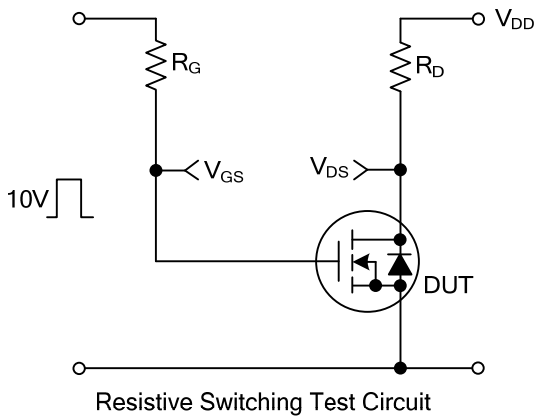
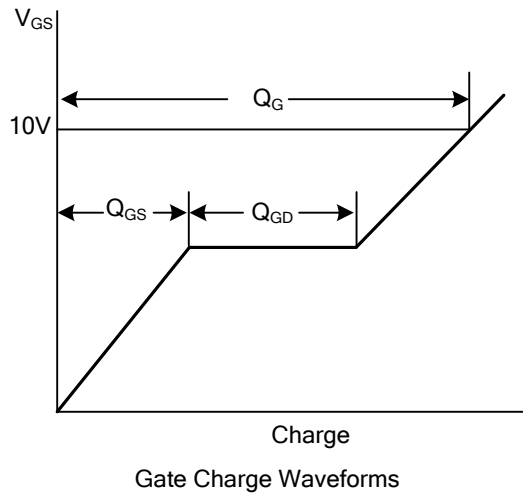
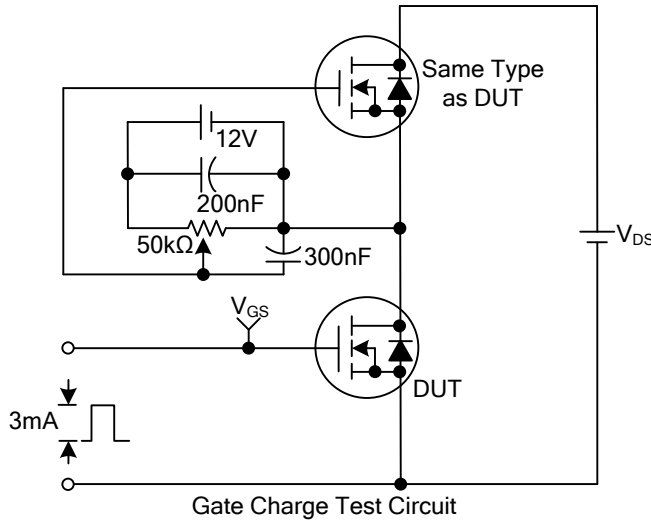
2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

Peak Diode Recovery dv/dt Test Circuit & Waveforms



■ TEST CIRCUITS AND WAVEFORMS(Cont.)



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